TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIV)

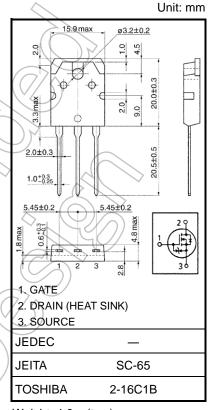
2SK3700

Switching Regulator Applications

- Low drain-source ON-resistance: RDS (ON) = 2.0Ω (typ.)
- High forward transfer admittance: |Yfs| = 4.5 S (typ.)
- Low leakage current: IDSS = $100 \mu A \text{ (max) (VDS} = 720 \text{ V)}$
- Enhancement model: Vth = 2.0 to 4.0 V (VDS = 10 V, ID = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	900	$(\nearrow \land)$	
Drain-gate voltage (RGS = 20 k Ω)		VDGR	900	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	5	A	
	Pulse (Note 1)	I _{DP}	15	V A	
Drain power dissipation	n (Tc=25°C)	PD	150	W	
Single pulse avalanche energy (Note 2)		EAS	351	mJ	
Avalanche current		IAR	5	A	
Repetitive avalanche e	nergy (Note 3)	EAR)) 15	mJ	
Channel temperature		Tch	150	∕ °C	
Storage temperature ra	ange	T _{stg}	−55 to150)°C	



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	0.833	°C/W
Thermal resistance, channel to ambient	Rth (ch-a)	50	°C/W

Note 1: Ensure that the temperature does not exceed 150°C.

Note 2: VDD = 90 V, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 25.7mH, $R_{G} = 25 \Omega$, $I_{AR} = 5 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

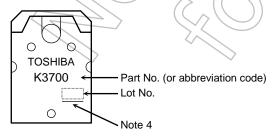
Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rrent	IGSS	V _G S = ±25 V, V _D S = 0 V	_	_	±10	μΑ
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \mu A$, $V_{DS} = 0 V$	±30	_	_	V
Drain cut-OFF cu	ırrent	I _{DSS}	V _{DS} = 720 V, V _{GS} = 0 V	7	_	100	μΑ
Drain-source bre	akdown voltage	V (BR) DSS	$I_G=10mA,\ V_{GS}=0\ V$	900	1		V
Gate threshold v	oltage	V _{th}	V _D S = 10 V, I _D = 1 mA	2.0)) }_	4.0	V
Drain-source ON	resistance	RDS (ON)	VGS = 10 V, ID = 3 A)/ <u>/</u>	2.0	2.5	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 20 V, I _D = 3 A	2.0	4.5	_	S
Input capacitance	Э	C _{iss}		1	1150	-	
Reverse transfer	capacitance	Crss	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	20	_	pF
Output capacitance		Coss		_	100	_	
Switching time	Rise time	t _r	V _{GS} I _D = 3 A V _{OUT}	- (30		
	Turn-ON time	t _{on}	0 V	~_((70) –	- ns
	Fall time	tf		7	60	_	
	Turn-OFF time	t _{off}	Duty ≤ 1%, t _w = 10 μs		170	-	
Total gate charge (gate-source plus		Qg) _	28		
Gate-source cha	rge	Qgs	VDD≈400 V, VGS = 10 V, ID = 5 Å	_	17	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	11	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	/ I _{DR}	(7/\ -	_	_	5	Α
Pulse drain reverse current (Note 1)	IDRP	<u> </u>	_	_	15	Α
Forward voltage (diode)	VDSF	IDR = 5 A, VGS = 0 V	_	_	-1.7	V
Reverse recovery time	trr	I _{DR} = 5 A, V _{GS} = 0 V,	_	900	_	ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs	_	5.4	_	μС

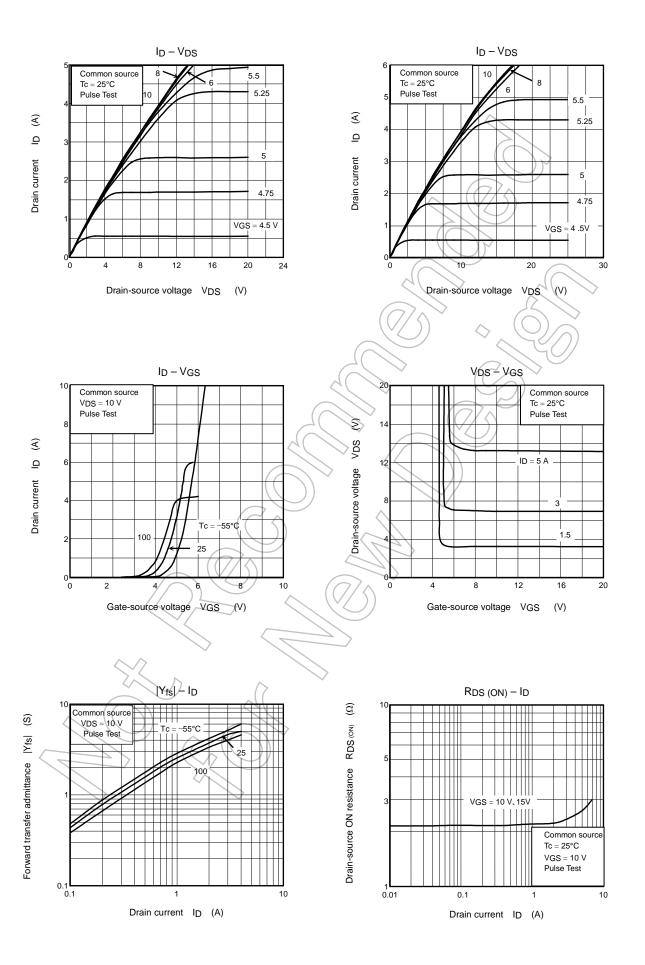
Marking



Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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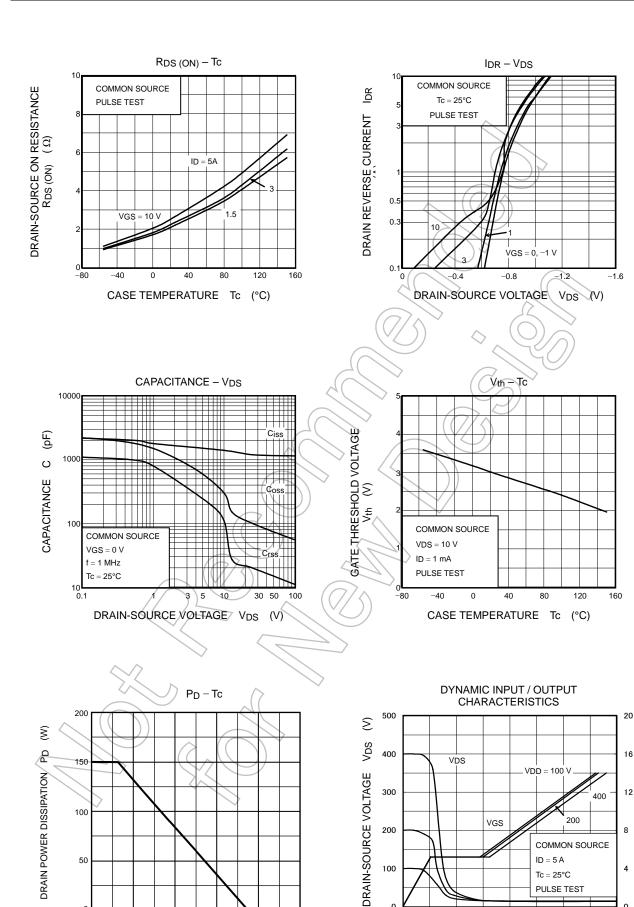
CASE TEMPERTATURE Tc (°C)

 \geq

Vgs

GATE-SOURCE VOLTAGE

40



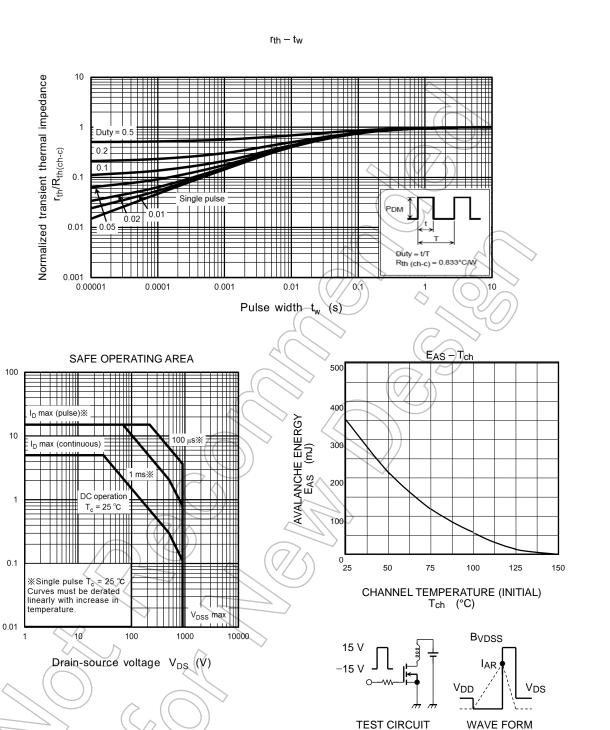
20

TOTAL GATE CHARGE $\ Q_g\ (nC)$

0

 $\widehat{\leq}$

Drain current I_D



 $R_G = 25 \Omega$

5

 $V_{DD} = 90 \text{ V}, L = 25.7\text{mH}$

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 $EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$

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